Lose the lag. Lose the limits.

The Intel[®] Solid-State Drive 530 Series offers the Next Generation of Consumer Computing

Utilizing its new small form factor, higher performance, and low Idle power, it's the next evolution of the Intel[®] Solid-State Drive.

Intel Evolving Storage Technology

Intel® Solid-State Drives (Intel® SSDs) continue to evolve with the introduction of the Intel® SSD 530 Series - aimed at a wide array of consumer platforms including Ultrabook™, traditional desktops and laptops, as well as the latest tablets and small form factor mobile systems. Intel® Solid-State Drive 530 Series offers high quality, reliable performance and low power consumption for space conscious computing using M.2, mSATA and 2.5" (7mm) form factors.

New Small Form Factor Introduction

The Intel SSD 530 Series product paves the way for thin and light computing devices by introducing the latest M.2 form factor. Intel's SSD M.2 form factor shrinks the total storage area significantly versus traditional 2.5" form factor storage devices. Along with the M.2 form factor, Intel SSD 530 Series is also available in mSATA and traditional 2.5" form factors enabling the technology in a variety of solutions. The Intel SSD 530 series product line comes in a wide range of capacities from 80GB to 480GB.

A New Generation of Power-Efficient Performance

The Intel[®] SSD 530 Series accelerates platform performance with sequential read and write performance up to 540 and 490 megabytes per second (MB/s) Random read and write input/output operations per second (IOPs) reach up to 41K and 80K respectively. With the Intel SSD 530 Series, your computer will blaze through the most demanding consumer client applications and easily handle intense multi-tasking. In addition to strong performance gains, Intel SSD 530 Series provides extended battery life through new lower power modes. Idle power consumption of Intel SSD 530 Series is reduced by >90% in comparison to a typical hard disc drive reducing power from watts to milliwatts. When the Intel SSD 530 Series is coupled with a 4th generation Intel[®] Core based platform, advanced power mode settings reduce power dissipation, another order of magnitude – from milliwatts to microwatts.

World-Class Reliability with the latest NAND Technology

With the Intel[®] SSD 530 Series using the latest 20nm Intel NAND technology, you also benefit from the high quality and reliability you've come to expect from Intel. In addition to the power, space savings, reliability, and peace of mind, the Intel SSD 530 Series is supported with Intel's outstanding warranty and customer support.



Intel[®] Solid-State Drive 530 Series

Technical Specifications ¹							
Model Name	Intel® Solid-State Drive 530 Series						
Capacity(GB) ²	M.2- 80, 120, 180, 36			50; MSATA - 80, 120, 180, 240; 2.5 " - 80, 120, 180, 240, 360, 480			
NAND Flash Memory	20nm Intel® NAND Flash Memory Multi-Level Cell (MLC)						
	Form Factor Capacity Point			Sequential Read (up to)	Sequential Write (up to)	Random Read (up to)	Random Write (up to)
Bandwidth ^{2, 3}	m.2 80gb, 120gb, 180gb, 360gb		DGB	540 MB/s	490 MB/s	41K IOPs	80K IOPs
	mSATA 80GB, 120GB, 180GB, 240GB		DGB	540 MB/s	490 MB/s	41K IOPs	80K IOPs
	2.5″ 80GB, 120GB, 180GB, 240GB, 360GB, 480GB		DGB,	540 MB/s	490 MB/s	41K IOPs	80K IOPs
Interface SATA 6Gb/s, compatible with SATA 3Gb/s							
		Form Factor		Height/Weight			
		M.2 (80mm)		Up to 3.7mm / up to 10 grams			
Form Factor, Height and Weight		mSATA			Up to 3.8mm / up to 10 grams		
		2.5″			Up to 7mm / up to 78 grams		
Life Expectancy		1.2 million hours Mean Time Between Failures (MTBF)					
Power Consumption M.2		Active: 140 mW Typical ⁵			Idle: 55 mW Ty	vpical ⁶ DevSle	ep: 200µW
Power Consumption mSATA		Active: 140 mW Typical ⁵			Idle: 55 mW Ty	pical ⁶ DevSle	ep: 200µW
Power Consumption 2.5"		Active: 195 mW Typical ⁵			Idle: 125 mW Typical ⁶ DevSleep: 5mW		
Operating Temperature		0° C to 70° C					
RoHS Compliance		Meets the requirements of European Union (EU) RoHS Compliance Directives					
Software Tools		Intel® Solid-State Drive Toolbox with Intel® SSD Optimizer at <u>www.intel.com/go/ssdtoolbox</u> Intel® Data Migration Software at <u>www.intel.com/go/ssdinstallation</u>					

¹ Based on the Intel[®] Solid-State Drive 530 Series Product Specification.

² All capacities and form factors will not be available at launch.

³ Performance varies by capacity and is measured using lometer* with Queue Depth 32.

⁴ Performance measured using lometer with Queue Depth 32. Measurements are performed on 8GB of logical block address (LBA) range on a full SSD.

⁵ Active power measured during execution of MobileMark* 2007 Workload with SATA Link Power Management (LPM) enabled.

⁶ Idle power defined as SSD at idle with SATA Link Power Management (LPM) enabled.

Solid-State Computing Starts with Intel Inside®- For more information, visit www.intel.com/go/ssd

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